

2021 / 2022 Tower Semiconductor MPW Schedule

| | Fab | | Tape-In | Ship Date |
|---|---------------|-----------------------------------|----------|-----------|
| SB*18 B4616 | NPB - Fab 3 | SiGe BiCMOS 0.18um | 12/07/21 | 06/15/22 |
| <i>Please contact your sales representative for information on fast track processing.</i> | | | | |
| SB*18 B5001 | NPB - Fab 3 | SiGe BiCMOS 0.18um | 02/08/22 | 08/16/22 |
| <i>Please contact your sales representative for information on fast track processing.</i> | | | | |
| PH18MA B5002 | NPB - Fab 3 | SiPho 0.18um | 02/22/22 | 07/08/22 |
| CA18 B5003 | NPB - Fab 3 | RFCMOS 0.18um | 03/15/22 | 08/24/22 |
| <i>Please contact your sales representative for information on fast track processing.</i> | | | | |
| SB*18 B5004 | NPB - Fab 3 | SiGe BiCMOS 0.18um | 04/05/22 | 10/11/22 |
| <i>Please contact your sales representative for information on fast track processing.</i> | | | | |
| SH222T18MAY | MH - Fab 2 | CIS 0.18um Image Sensor | 05/16/22 | |
| | | CMOS+ 0.16um, 0.18um RF, RFID, PM | 05/23/22 | |
| 21st MPW Tonami, Japan | TPSCo - Fab 5 | TS18 | 05/30/22 | |
| | | CMOS 0.18u & 0.16u, PM, PM_SOI | | |
| PH18MA B5006 | NPB - Fab 3 | SiPho 0.18um | 05/31/22 | 10/14/22 |
| SB*18 B5007 | NPB - Fab 3 | SiGe BiCMOS 0.18um | 06/14/22 | 12/20/22 |
| <i>Please contact your sales representative for information on fast track processing.</i> | | | | |
| CS18* B5005 | MH - Fab 2 | CMOS-SOI 0.18um | 06/28/22 | |
| PH18MA B5008 | NPB - Fab 3 | SiPho 0.18um | 07/19/22 | 12/02/22 |
| SH322T18AUG | MH - Fab 2 | CIS 0.18um Image Sensor | 08/08/22 | |
| | | CMOS+ 0.16um, 0.18um RF, RFID, PM | 08/15/22 | |

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| SB*18 B5009 | NPB - Fab 3 | SiGe BiCMOS 0.18um | 08/09/22 | 02/14/23 |
| <i>Please contact your sales representative for information on fast track processing.</i> | | | | |
| CS18* B5010 | MH - Fab 2 | CMOS-SOI 0.18um | 08/23/22 | |
| 22nd MPW Tonami, Japan | TPSCo - Fab 5 | TS18 CMOS 0.18u & 0.16u, PM, PM_SOI | 08/29/22 | |
| SB*/CA/13* B5011 | NPB - Fab 3 | SiGe BiCMOS / RF CMOS 0.13um | 08/30/22 | 04/26/23 |
| <i>Please contact your sales representative for information on fast track processing.</i> | | | | |
| CA18 B5012 | NPB - Fab 3 | RFCMOS 0.18um | 09/13/22 | 02/21/23 |
| <i>Please contact your sales representative for information on fast track processing.</i> | | | | |
| 22nd MPW Uozu, Japan | TPSCo - Fab 7 | CMOS, PM & RFCMOS 65nm : TPS65SLA/SLC, TPS65PMA/PMB/MSA/MSB, TPS65RF | 09/26/22 | |
| SB*18 B5013 | NPB - Fab 3 | SiGe BiCMOS 0.18um | 10/04/22 | 04/11/23 |
| <i>Please contact your sales representative for information on fast track processing.</i> | | | | |
| 23rd MPW Uozu, Japan | TPSCo - Fab 7 | RFSOI 65nm:TPS90RSB2, TPS65RSA2/RSB | 10/17/22 | |
| PH18MA B5014 | NPB - Fab 3 | SiPho 0.18um | 11/01/22 | 03/17/23 |
| SH422T18NOV | MH - Fab 2 | CIS 0.18um Image Sensor CMOS+ 0.16um, 0.18um RF, RFID, PM 0.18 BSI, Stacking on 0.13 | 11/14/22 11/21/22 11/14/22 | |
| 23rd MPW Tonami, Japan | TPSCo - Fab 5 | TS18 CMOS 0.18u & 0.16u, PM, PM_SOI | 11/28/22 | |

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|-------|---|--------------------|----------|-----------|
| SB*18 | NPB - Fab 3 | SiGe BiCMOS 0.18um | 12/06/22 | 06/13/23 |
| B5015 | <i>Please contact your sales representative for information on fast track processing.</i> | | | |

Notes :

"Shuttles" (SH*) are run at Fab 2

* 0.13u MH - fab 2 Shuttle / MPW slots will be considered per needs

Please contact your customer account manager for additional information.

Fab2 -- Tower Semiconductor 200mm wafer fabrication facility at Migdal Ha'emek, Israel

Fab3 -- Tower Semiconductor 200mm wafer fabrication facility at Newport Beach, CA

Fab5 -- Tower Semiconductor 200mm wafer fabrication facility at Tonami, Japan

Fab7 -- Tower Semiconductor 300mm wafer fabrication facility at Uozu, Japan